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IKT-BI-3854-SKAP-MP



Design verification as per IEC/EN 61439

Heat dissipation, at an ambient temperature of 35°C, delta T: 20 degrees, calculated as per IEC 60890 Individual enclosure for wall mounting Pv C0 38 Starting enclosure for wall mounting Pv C0 33 Heat dissipation, at an ambient temperature of 35°C, delta T: 35 degrees, calculated as per IEC 60890 Individual enclosure for wall mounting Pv C0 77 Starting enclosure for wall mounting Pv C0 72 Middle enclosure for wall mounting Pv C0 66				
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	10.11 Short-circuit rating			Is the panel builder's responsibility.
10.13 Mechanical function Meets the product standard's requirements.	10.12 Electromagnetic compatibility			Is the panel builder's responsibility.
	10.13 Mechanical function			Meets the product standard's requirements.